New Jersey Semi-Conductor Products, Inc.

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The RF Line

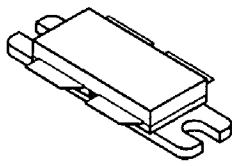
NPN Silicon RF Power Transistor

MRF899

Designed for 26 Volt UHF large–signal, common emitter, Class AB linear amplifier applications in industrial and commercial FM/AM equipment operating in the range 800–960 MHz.

- Specified 26 Volt, 900 MHz Characteristics
  - Output Power = 150 Watts (PEP)
  - Minimum Gain = 8.0 dB @ 900 MHz, Class AB
  - Minimum Efficiency = 35% @ 900 MHz, 150 Watts (PEP)
  - Maximum Intermodulation Distortion –28 dBc @ 150 Watts (PEP)
- Characterized with Series Equivalent Large–Signal Parameters from 800 to 960 MHz
- Silicon Nitride Passivated
- 100% Tested for Load Mismatch Stress at all Phase Angles with 5:1 VSWR @ 26 Vdc, and Rated Output Power
- Gold Metallized, Emitter Ballasted for Long Life and Resistance to Metal Migration
- Circuit board photomaster available upon request by contacting RF Tactical Marketing in Phoenix, AZ.

150 W, 900 MHz
RF POWER
TRANSISTOR
NPN SILICON



CASE 375A–01, STYLE 1

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V_{CEO}	28	Vdc
Collector–Emitter Voltage	V_{CES}	60	Vdc
Emitter–Base Voltage	V_{EBO}	4.0	Vdc
Collector–Current — Continuous	I_C	25	Adc
Total Device Dissipation @ T_C = 25°C Derate above 25°C	P_D	230 1.33	Watts W/°C
Storage Temperature Range	T_{stg}	–65 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.75	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

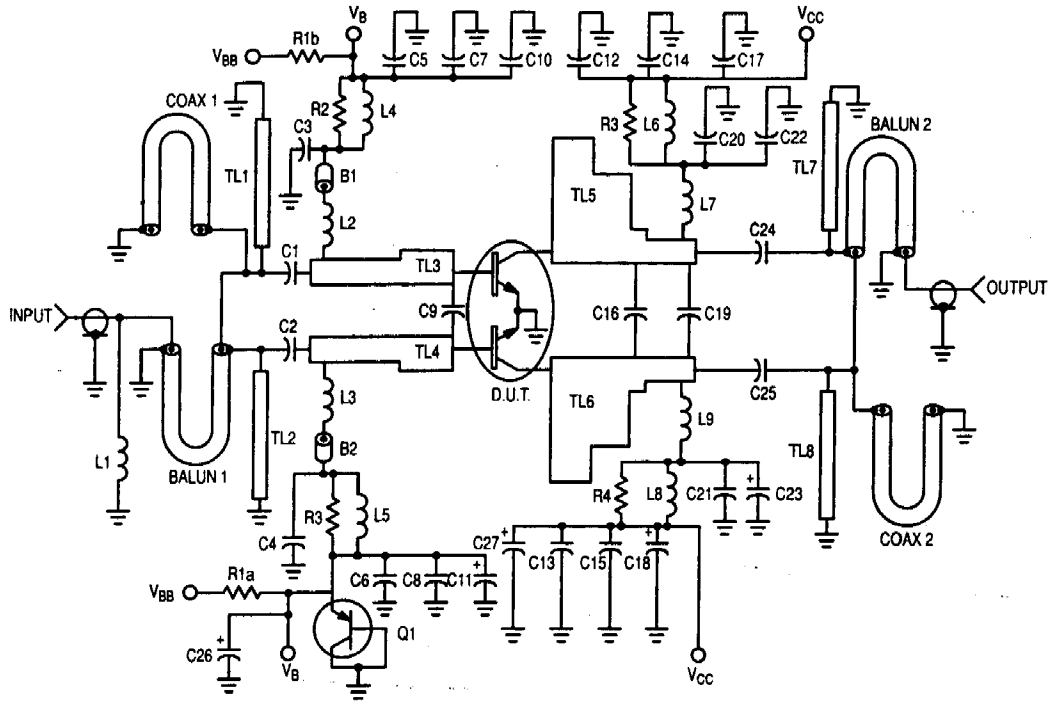
Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector–Emitter Breakdown Voltage (I_C = 100 mAdc, I_B = 0)	$V_{(BR)CEO}$	28	37	—	Vdc
Collector–Emitter Breakdown Voltage (I_C = 50 mAdc, V_{BE} = 0)	$V_{(BR)CES}$	60	85	—	Vdc
Emitter–Base Breakdown Voltage (I_E = 10 mAdc, I_C = 0)	$V_{(BR)EBO}$	4.0	4.9	—	Vdc
Collector Cutoff Current (V_{CE} = 30 Vdc, V_{BE} = 0)	I_{CES}	—	—	10	mAdc
ON CHARACTERISTICS					
DC Current Gain (I_{CE} = 1.0 Adc, V_{CE} = 5.0 Vdc)	h_{FE}	30	75	120	—
DYNAMIC CHARACTERISTICS					
Output Capacitance (V_{CB} = 26 Vdc, I_E = 0, f = 1.0 MHz) (1)	C_{ob}	—	75	—	pF

(1) For information only. This part is collector matched.

(continued)

ELECTRICAL CHARACTERISTICS — continued (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
FUNCTIONAL CHARACTERISTICS					
Common–Emitter Amplifier Power Gain V_{CC} = 26 Vdc, P_{out} = 150 Watts (PEP), I_{cq} = 300 mA, f_1 = 900 MHz, f_2 = 900.1 MHz	G_{pe}	8.0	9.0	—	dB
Collector Efficiency V_{CC} = 26 Vdc, P_{out} = 150 Watts (PEP), I_{cq} = 300 mA, f_1 = 900 MHz, f_2 = 900.1 MHz	η	30	40	—	%
3rd Order Intermodulation Distortion V_{CC} = 26 Vdc, P_{out} = 150 Watts (PEP), I_{cq} = 300 mA, f_1 = 900 MHz, f_2 = 900.1 MHz	IMD	—	–32	–28	dBc
Output Mismatch Stress V_{CC} = 26 Vdc, P_{out} = 150 Watts (PEP), I_{cq} = 300 mA, f_1 = 900 MHz, f_2 = 900.1 MHz, VSWR = 5:1 (all phase angles)	ψ	No Degradation in Output Power Before and After Test			



B1, B2 — Ferrite Bead, Ferroxcube #56–590–65–3B
C1, C2, C24, C25 — 43 pF, B Case, ATC Chip Capacitor
C3, C4, C20, C21 — 100 pF, B Case, ATC Chip Capacitor
C5, C6, C12, C13 — 1000 pF, B Case, ATC Chip Capacitor
C7, C8, C14, C15 — 1800 pF, AVX Chip Capacitor
C9 — 9.1 pF, A Case, ATC Chip Capacitor
C10, C11, C17, C18, C22, C23 — 10 μF, Electrolytic Capacitor Panasonic
C16 — 3.9 pF, B Case, ATC Chip Capacitor
C19 — 0.8 pF, B Case, ATC Chip Capacitor
C26 — 200 μF, Electrolytic Capacitor Mallory Sprague
C27 — 500 μF Electrolytic Capacitor
L1 — 5 Turns 24 AWG IDIA 0.059″ Choke, 19.8 nH
L2, L3, L7, L9 — 4 Turns 20 AWG IDIA 0.163″ Choke
L4, L5, L6, L8 — 12 Turns 22 AWG IDIA 0.140″ Choke
N1, N2 — Type N Flange Mount, Omni Spectra
Q1 — Bias Transistor BD136 PNP
R2, R3, R4, R5 — 4.0 x 39 Ohm 1/8 W Chips in Parallel
R1a, R1b — 56 Ohm 1.0 W
TL1–TL8 — See Photomaster
Balun1, Balun2, Coax 1, Coax 2 — 2.20″ 50 Ohm 0.088″ o.d. Semi–rigid Coax, Micro Coax
Board — 1/32″ Glass Teflon, ε_r = 2.55″ Arlon (GX–0300–55–22)

Figure 1. 900 MHz Power Gain Test Circuit